

BD81A74-TSB-001 Gerber file

PCB Layer structure	PCB層構造(Japanese)	File Name
TOP Silkscreen	Top Silk	BD81A74EFV-TSB-001-F_SilkS.gbr
Top Resist	Top Resist	BD81A74EFV-TSB-001-F_Mask.gbr
Top Layer	Top Metal (M1)	BD81A74EFV-TSB-001-F_Cu.gbr
Inner Layer1	内層1 (M2)	BD81A74EFV-TSB-001-In1_Cu.gbr
Inner Layer2	内層2 (M3)	BD81A74EFV-TSB-001-In2_Cu.gbr
Bottom Layer	Bottom Metal (M4)	BD81A74EFV-TSB-001-B_Cu.gbr
Bottom Resist	Bottom Resist	BD81A74EFV-TSB-001-B_Mask.gbr
Bottom Silkscreen	Bottom Silk	BD81A74EFV-TSB-001-B_SilkS.gbr
PCB Out-line	基板外形	BD81A74EFV-TSB-001-Edge_Cuts.gbr
Plated Through Hole	メッキ穴	BD81A74EFV-TSB-001-PTH.drd